



Knowledge in Process

For Immediate Release

Speedline Receives Two EM Asia Innovation Awards

SINGAPORE – 21 April 2008 – Speedline Technologies was honored with two Innovation Awards from EM Asia magazine during ceremonies held April 9th at the Nepcon China trade event in Shanghai. The awards were received for the Electrovert DwellMax Plus™ Nozzle System in the Wave Soldering category and Electrovert Intelligent Flux Control™ (IFC) with RunMax™ Technology in the Reflow Soldering category. Top performing companies were recognized for achieving the highest standards in the various manufacturing-related products, materials and equipment.

Electrovert's DwellMax Plus nozzle system provides a new process solution to the challenges of wave soldering with lead-free alloys. The patent-pending nozzle design also addresses the difficult process issues surrounding wave soldering of thick, thermally massive boards. Greg Calvo, product manager for wave and reflow soldering systems commented, "The DwellMax Plus nozzle system addresses process challenges associated with lead-free alloys that often result in bridging and insufficient hole fill. This system incorporates a wide nozzle that improves hole fill, increases throughput, and increases yields."

The new Intelligent Flux Control system provides superior control and collection of flux within the reflow oven. Understanding that high volume electronics manufacturers demand minimal downtime for maintenance, the IFC is an advanced flux management system that incorporates self-clean features and does not require interruption of production for maintenance activities.

In receiving the awards on behalf of Speedline, Mr. Calvo added, "Electrovert has been an innovator in soldering technology for over 57 years. We are extremely pleased to have been recognized by EM Asia in both the wave and reflow categories."

A ceremony sponsored by EM Asia magazine was held at the Shanghai Everbright International Hotel to honor recipients of the Innovation Awards. Key industry associations including iNEMI,

IPC, SMTA, Tsinghua University SMTLAB and Guangzhou Electronics Manufacturing Association (SMT) were present to show support for the program.

For details on the award, please visit www.emasiomag.com/awards2008/. For information on the Electrovert DwellMax Plus wave soldering nozzle system and Intelligent Flux Control, please visit www.speedlinetech.com.

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CAPTION:

Speedline's Greg Calvo Receives One of Two EM Asia Innovation Awards.

NOTE: For high resolution photo, contact smfong@speedlinetech.com

About Speedline Technologies

Speedline Technologies is the global leader in process knowledge, services and manufacture of capital equipment used in printed circuit board assembly and semiconductor industries. Based in Franklin, Massachusetts, USA, the company markets five best-in-class brands: Accel microelectronics cleaning equipment; Camalot dispensing systems; Electrovert wave soldering, reflow soldering and cleaning equipment; MPM stencil and screen printing systems; and Protect global services, support and training solutions.

For more information about Speedline Technologies visit www.speedlinetech.com or contact Speedline at:

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